

## Specifications

Insulation Resistance:	500M $\Omega$ min. at 500V DC
Withstanding Voltage:	250V ACrms for 1 minute
Contact Resistance:	100m $\Omega$ max. at 10mA / 20mV max.
Current Rating:	0.5A
Voltage Rating:	5.0Vrms
Operating Temp. Range:	-55°C to +85°C
Mating Cycles:	5,000 insertions

## Part Number (Details)

**FMS006 - 200 0 - 0**

Series No.

Design No.

0 = without Switch

## Materials and Finish

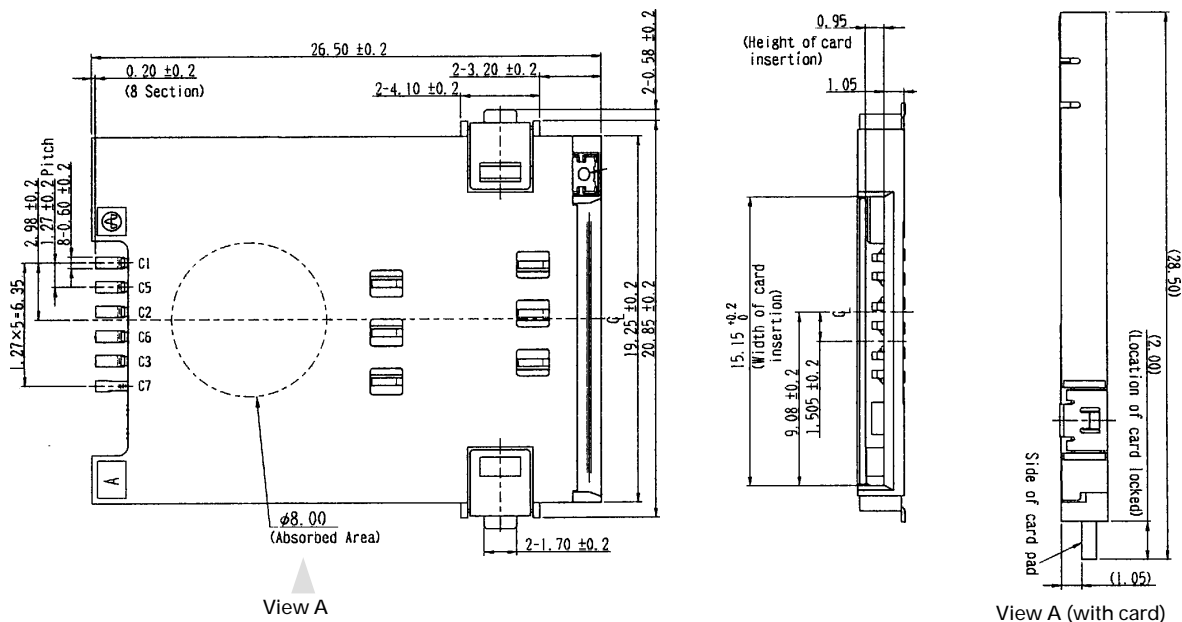
Insulator:	- LCP, glass filled (UL94V-0)
Contact Plating:	Mating Face - Gold over Nickel
	Solder Tails - SnPb over Nickel



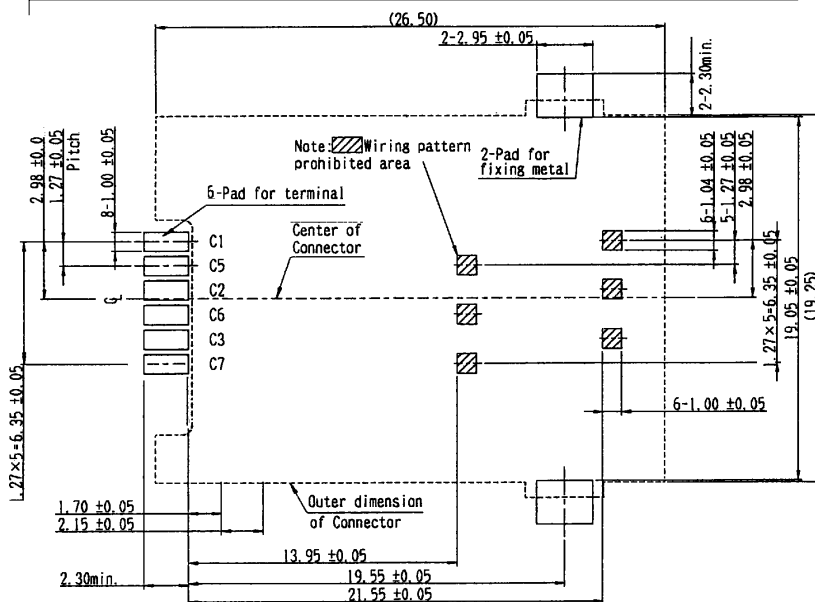
## Features

- Conforms to GSM11.11 standard for the European mobile phone system
- Smooth extraction function by Push / Push mechanism
- Without switch
- For assembly on top of the PC-Board
- Tape and Reel Packaging (800 pcs./reel)

## Outline Connector Dimensions (reference only)



## Recommended PCB Layout (Mounting Side)



## Card Insertion

